onsemi

$\frac{\text{MOSFET}}{\text{COOL}^{\text{®}}} - \text{Power, DUAL}$ $\frac{\text{COOL}^{\text{®}}}{\text{N-Channel, DFN8}}$ $\frac{120 \text{ V, 6.1 m}\Omega, 92 \text{ A}}{\text{NTMFSC006N12MC}}$

Features

- Advanced Dual-sided Cooled Packaging
- Ulra Low R_{DS(on)}
- MSL1 Robust Packaging Design

Typical Applications

- Primary DC-DC FET
- Synchronous Rectifier
- DC-DC Conversion

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

| Parar | neter | | Symbol | Value | Unit |
|---|---------------------|----------------------------|-----------------------------------|-------|------|
| Drain-to-Source Voltage | | V _{DSS} | 120 | V | |
| Gate-to-Source Voltage | Э | | V _{GS} | ±20 | V |
| Continuous Drain Cur- | Steady | $T_{C} = 25^{\circ}C$ | I _D | 92 | А |
| rent $R_{\theta JC}$ (Notes 1, 3) | State | $T_{C} = 100^{\circ}C$ | | 57 | 1 |
| Power Dissipation | | $T_{C} = 25^{\circ}C$ | PD | 104 | W |
| R _{θJC} (Note 1) | | $T_{C} = 100^{\circ}C$ | | 41 | 1 |
| Continuous Drain | Steady State | $T_A = 25^{\circ}C$ | ۱ _D | 14 | А |
| Current R _{θJA} (Notes 1, 2, 3) | | T _A = 100°C | | 9 | |
| Power Dissipation | | T _A = 25°C | PD | 2.7 | W |
| $R_{\theta JA}$ (Notes 1, 2) | | $T_A = 100^{\circ}C$ | | 1.1 | |
| Pulsed Drain Current | T _C = 25 | °C, t _p = 10 μs | I _{DM} | 1459 | А |
| Operating Junction / Storage Temperature Max | | | T _J , T _{stg} | +150 | °C |
| Source Current (Body Diode) | | | I _S | 86 | А |
| Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 53 \text{ A}$) | | E _{AS} | 114 | mJ | |
| Lead Temperature Soldering Reflow for Solder- ing Purposes (1/8" from case for 10 s) | | | ΤL | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

| Parameter | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Junction-to-Case - Steady State | $R_{\theta JC}$ | 1.2 | °C/W |
| Junction-to-Case Top - Steady State | $R_{\theta JT}$ | 1.53 | |
| Junction-to-Ambient - Steady State (Note 2) | $R_{\theta JA}$ | 45 | |

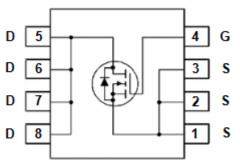
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 $\rm mm^2,$ 2 oz. Cu pad.

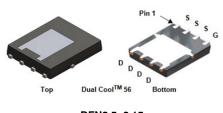
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

| V _{(BR)DSS} | R _{DS(ON)} MAX | I _D MAX |
|----------------------|-------------------------|--------------------|
| 120 V | 6.1 mΩ @ 10 V | 92 A |

N-CHANNEL MOSFET

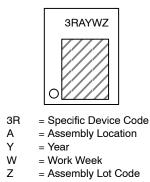


MARKING DIAGRAM



DFN8 5x6.15 CASE 506EG

MARKING DIAGRAM



ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|-------------------|-----------------------|
| NTMFSC006N12MC | DFN8 (Pb-Free) | 3000 / Tape & Reel |

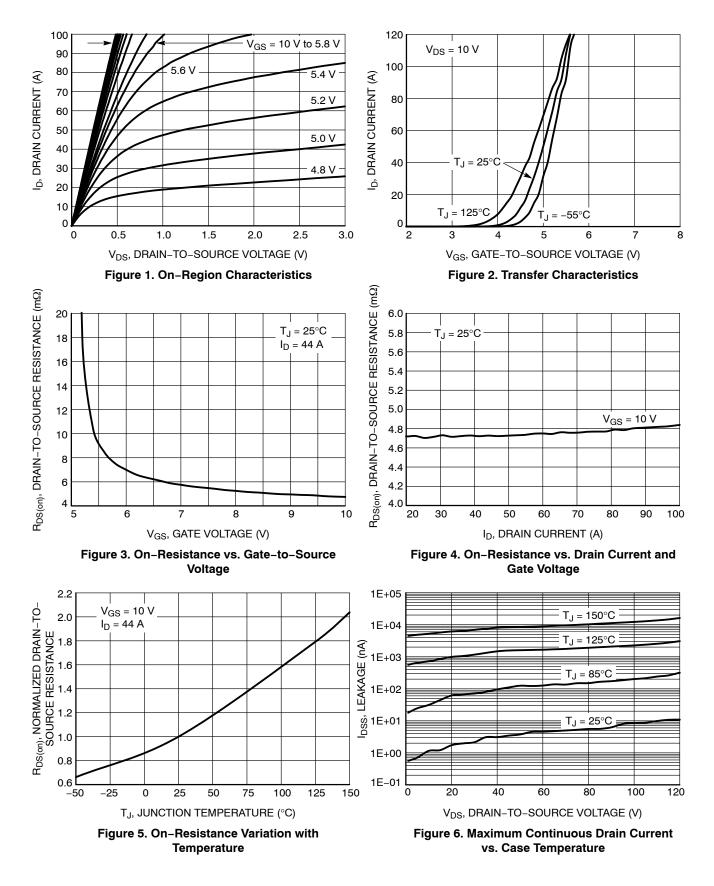
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

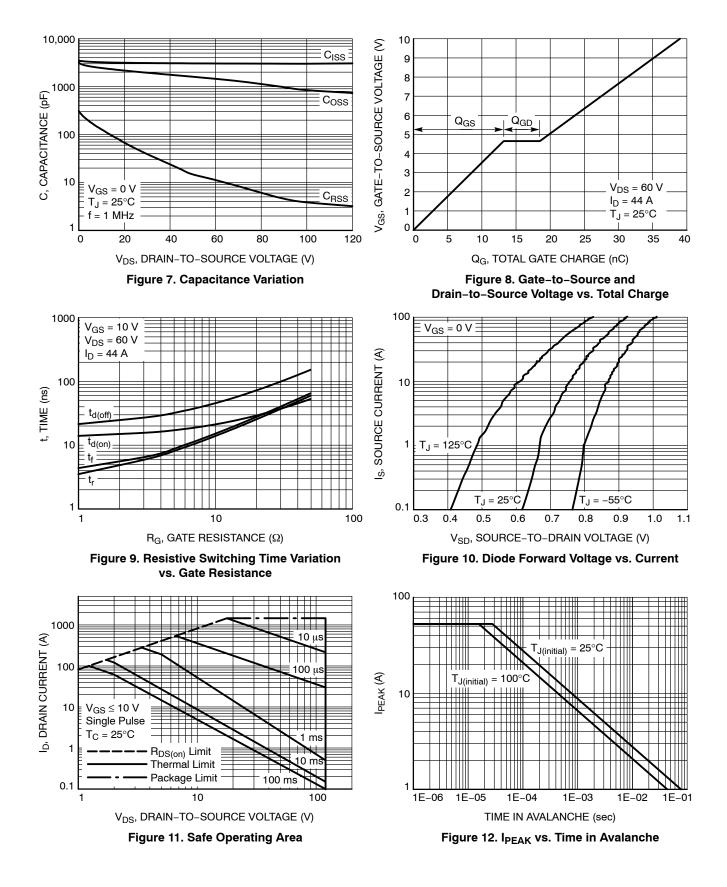
| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|--|--|--|------------------------|-----|-------|-----|-------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V_{GS} = 0 V, I _D = 250 μ A | | 120 | | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} / T _J | $I_D = 250 \ \mu\text{A}, \text{ ref to } 25^{\circ}\text{C}$ | | | 16 | | mV/°C |
| Zero Gate Voltage Drain Current | $\label{eq:Drain Current} Drain Current \qquad I_{DSS} \qquad \begin{array}{c} V_{GS} = 0 \ V, \\ V_{DS} = 120 \ V \end{array} \qquad \begin{array}{c} T_J = 25^\circ C \\ \hline T_J = 125^\circ C \end{array}$ | $T_J = 25^{\circ}C$ | | | 5 | μA | |
| | | V _{DS} = 120 V | T _J = 125°C | | | 100 | 1 |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} | = 20 V | | | 100 | nA |
| ON CHARACTERISTICS (Note 4) | | | | - | - | - | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}, I_D =$ | 250 μA | 2 | | 4 | V |
| Negative Threshold Temperature Coefficient | V _{GS(TH)} /T _J | I _D = 250 μA, ref | to 25°C | | 9.8 | | mV/∘C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 44 A | | 4.7 | 6.1 | mΩ |
| Gate-Resistance | R _G | T _A = 25° | 0 | | 1.4 | | Ω |
| CHARGES & CAPACITANCES | | | | | | | |
| Input Capacitance | C _{ISS} | V_{GS} = 0 V, f = 1 MHz, V_{DS} = 60 V | | | 3040 | | pF |
| Output Capacitance | C _{OSS} | | | | 1460 | | |
| Reverse Transfer Capacitance | C _{RSS} | | | | 11.5 | | |
| Total Gate Charge | Q _{G(TOT)} | V_{GS} = 6 V, V_{DS} = 60 V, I_{D} = 44 A | | | 24.3 | | nC |
| Total Gate Charge | Q _{G(TOT)} | V_{GS} = 10 V, V_{DS} = 60 V, I_{D} = 44 A | | | 39 | | |
| Gate-to-Source Charge | Q _{GS} | | | | 13.2 | | - |
| Gate-to-Drain Charge | Q _{GD} | | | | 6.3 | | |
| Plateau Voltage | V _{GP} | | | | 4.65 | | V |
| SWITCHING CHARACTERISTICS (Note 4) | | | | - | - | - | |
| Turn-On Delay Time | t _{d(ON)} | V _{GS} = 10 V, V _{DS} I _D = 44 A, R _G = | _S = 60 V, | | 15.2 | | ns |
| Rise Time | t _r | I _D = 44 A, R _G = 2.5 Ω | | | 5.3 | | |
| Turn-Off Delay Time | t _{d(OFF)} | | | | 25.5 | | 1 |
| Fall Time | t _f | | | | 5.7 | | |
| DRAIN-SOURCE DIODE CHARACTERISTIC | S | | | | | | |
| Forward Diode Voltage | V _{SD} | V _{GS} = 0 V, I _S = 44 A | $T_J = 25^{\circ}C$ | | 0.86 | | V |
| | | | T _J = 125°C | | 0.74 | | 1 |
| Reverse Recovery Time | t _{RR} | V_{GS} = 0 V, dI _S /dt = 1000 A/µs, I _S = 44 A | | | 33.4 | | ns |
| Reverse Recovery Charge | Q _{RR} | | | | 350.2 | | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

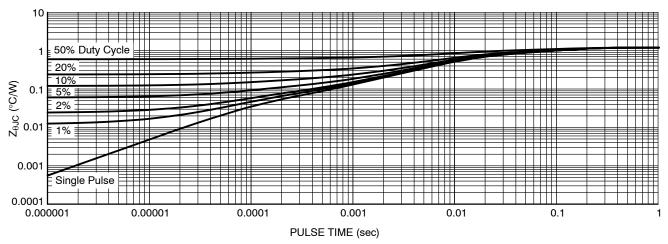
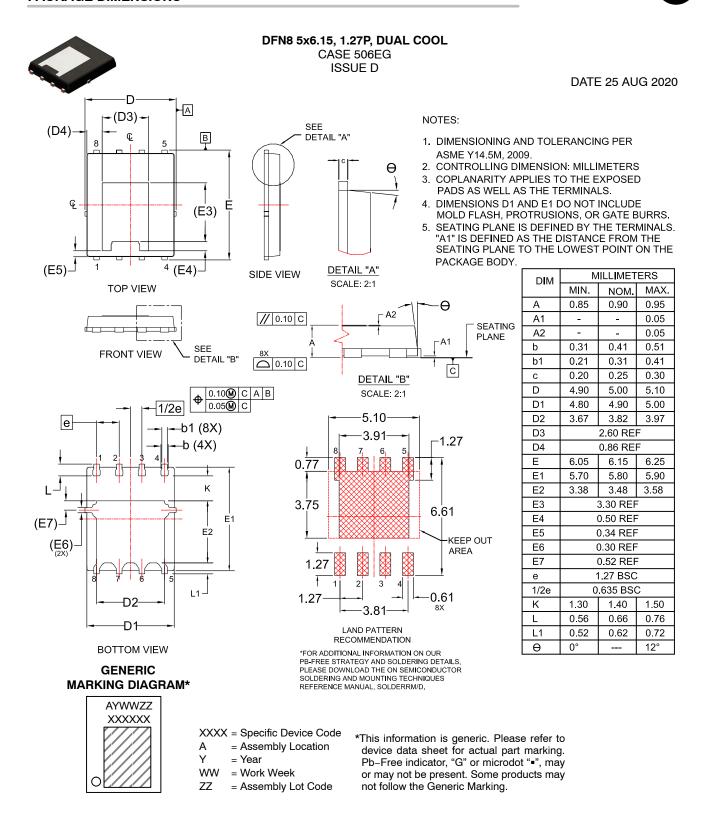


Figure 13. Thermal Characteristics

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|---------------------------------------|---|--|-------------|--|
| DESCRIPTION: | DFN8 5x6.15, 1.27P, DUAL COOL | | PAGE 1 OF 1 | |
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